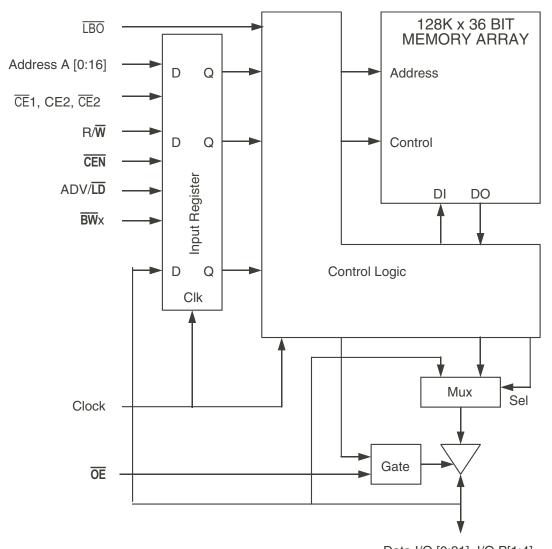


# 128K X 36, 3.3V Synchronous *IDT71V547S/XS* SRAM with ZBT™ Feature, Burst Counter and Flow-Through Outputs

#### **Features**

- ◆ 128K x 36 memory configuration, flow-through outputs
- Supports high performance system speed 95 MHz (8ns Clock-to-Data Access)
- ◆ ZBT<sup>TM</sup> Feature No dead cycles between write and read cycles
- Internally synchronized signal eliminates the need to control OE
- ◆ Single R/W (READ/WRITE) control pin
- 4-word burst capability (Interleaved or linear)
- ◆ Individual byte write (BW1 BW4) control (May tie active)
- Three chip enables for simple depth expansion
- Single 3.3V power supply (±5%)
- ◆ Packaged in a JEDEC standard 100-pin TQFP package

#### **Functional Block Diagram**



Data I/O [0:31], I/O P[1:4]

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**FEBRUARY 2015** 

### **Description**

The IDT71V547 is a 3.3V high-speed 4,718,592-bit (4.5 Megabit) synchronous SRAM organized as  $128K \times 36$  bits. It is designed to eliminate dead bus cycles when turning the bus around between reads and writes, or writes and reads. Thus it has been given the name ZBT<sup>TM</sup>, or Zero Bus Turn-around.

Address and control signals are applied to the SRAM during one clock cycle, and on the next clock cycle, its associated data cycle occurs, be it read or write.

The IDT71V547 contains address, data-in and control signal registers. The outputs are flow-through (no output data register). Output enable is the only asynchronous signal and can be used to disable the outputs at any given time.

A Clock Enable ( $\overline{\text{CEN}}$ ) pin allows operation of the IDT71V547 to be suspended as long as necessary. All synchronous inputs are ignored when  $\overline{\text{CEN}}$  is high and the internal device registers will hold their previous values.

There are three chip enable pins  $(\overline{CE}1, CE2, \overline{CE}2)$  that allow the user to deselect the device when desired. If any one of these three is not active when ADV/ $\overline{LD}$  is low, no new memory operation can be initiated and any burst in progress is stopped. However, any pending data transfers (reads or writes) will be completed. The data bus will tri-state one cycle after the chip was deselected or write initiated.

The IDT71V547 has an on-chip burst counter. In the burst mode, the IDT71V547 can provide four cycles of data for a single address presented to the SRAM. The order of the burst sequence is defined by the  $\overline{LBO}$  input pin. The  $\overline{LBO}$  pin selects between linear and interleaved burst sequence. The ADV/ $\overline{LD}$  signal is used to load a new external address (ADV/ $\overline{LD}$  = LOW) or increment the internal burst counter (ADV/ $\overline{LD}$  = HIGH).

The IDT71V547 SRAM utilizes IDT's high-performance, high-volume 3.3V CMOS process, and is packaged in a JEDEC Standard 14mm x 20mm 100-pin thin plastic quad flatpack (TQFP) for high board density.

### **Pin Description Summary**

| A0 - A16  | Address Inputs                           | Input  | Synchronous  |
|---|--|--------|--------------|
| CE1, CE2, CE2   | Three Chip Enables                       | Input  | Synchronous  |
| ŌĒ  | Output Enable                            | Input  | Asynchronous |
| R/W   | Read/Write Signal                        | Input  | Synchronous  |
| CEN   | Clock Enable                             | Input  | Synchronous  |
| $\overline{BW}_1$ , $\overline{BW}_2$ , $\overline{BW}_3$ , $\overline{BW}_4$ | Individual Byte Write Selects            | Input  | Synchronous  |
| CLK   | Clock                                    | Input  | N/A          |
| ADV/ <del>LD</del>  | Advance Burst Address / Load New Address | Input  | Synchronous  |
| <u>LBO</u>  | Linear / Interleaved Burst Order         | Input  | Static       |
| I/O0 - I/O31, I/OP1 - I/OP4   | Data Input/Output                        | I/O    | Synchronous  |
| Vdd   | 3.3V Power                               | Supply | Static       |
| Vss   | Ground                                   | Supply | Static       |

## Pin Definitions<sup>(1)</sup>

| Symbol                        | Pin Function                     | I/O | Active | Description  |  |  |
|-------------------------------|----------------------------------|-----|--------|--|--|--|
| A0 - A16                      | Address Inputs                   | I   | N/A    | Synchronous Address inputs. The address register is triggered by a combination of the rising edge of CLK, ADV/LD Low, CEN Low and true chip enables.   |  |  |
| ADV/LD                        | Address/Load                     | 1   | N/A    | ADV/\(\bar{L}\)D is a synchronous input that is used to load the internal registers with new address and control when it is sampled low at the rising edge of clock with the chip selected. When ADV/\(\bar{L}\)D is low with the chip deselected, any burst in progress is terminated. When ADV/\(\bar{L}\)D is sampled high then the internal burst counter is advanced for any burst that was in progress. The external addresses are ignored when ADV/\(\bar{L}\)D is sampled high.  |  |  |
| R/W                           | Read/Write                       | I   | N/A    | $R/\overline{W}$ signal is a synchronous input that identifies whether the current load cycle initiated is a Read or Write access to the memory array. The data bus activity for the current cycle takes place one clock cycle later.  |  |  |
| CEN                           | Clock Enable                     | I   | LOW    | Synchronous Clock Enable Input. When $\overline{\text{CEN}}$ is sampled high, all other synchronous inputs, including clock are ignored and outputs remain unchanged. The effect of $\overline{\text{CEN}}$ sampled high on the device outputs is as if the low to high clock transition did not occur. For normal operation, $\overline{\text{CEN}}$ must be sampled low at rising edge of clock.   |  |  |
| BW1 - BW4                     | Individual Byte<br>Write Enables | -   | LOW    | Synchronous byte write enables. Enable 9-bit byte has its own active low byte write enable. On load write cycles (When $R/\overline{W}$ and $ADV/L\overline{D}$ are sampled low) the appropriate byte write signal ( $\overline{BW}1$ - $\overline{BW}4$ ) must be valid. The byte write signal must also be valid on each cycle of a burst write. Byte Write signals are ignored when $R/\overline{W}$ is sampled high. The appropriate byte(s) of data are written into the device one cycle later. $\overline{BW}1$ - $\overline{BW}4$ can all be tied low if always doing write to the entire 36-bit word. |  |  |
| CE1, CE2                      | Chip Enables                     | -   | LOW    | Synchronous active low chip enable. $\overline{\text{CE}}_1$ and $\overline{\text{CE}}_2$ are used with CE2 to enable the IDT71V547. $\overline{\text{CE}}_1$ or $\overline{\text{CE}}_2$ sampled high or CE2 sampled low) and ADV/ $\overline{\text{LD}}$ low at the rising edge of clock, initiates a deselect cycle. This device has a one cycle deselect, i.e., the data bus will tri-state one clock cycle after deselect is initiated.   |  |  |
| CE2                           | Chip Enable                      | I   | HIGH   | Synchronout active high chip enable. CE2 is used with $\overline{\text{CE}}_1$ and $\overline{\text{CE}}_2$ to enable the chip. CE2 has inverted polarity but otherwise identical to $\overline{\text{CE}}_1$ and $\overline{\text{CE}}_2$ .   |  |  |
| CLK                           | Clock                            | I   | N/A    | This is the clock input to the IDT71V547. Except for $\overline{\text{OE}}$ , all timing references for the device are made with respect to the rising edge of CLK.  |  |  |
| I/O0 - I/O31<br>I/OP1 - I/OP4 | Data Input/Output                | I/O | N/A    | Data input/output (I/O) pins. The data input path is registered, triggered by the rising edge of CLK. The data output path is flow-through (no output register).   |  |  |
| LBO                           | Linear Burst<br>Order            | I   | LOW    | Burst order selection input. When $\overline{LBO}$ is high the Interleaved burst seguence is selected. When $\overline{LBO}$ is low the Linear burst sequence is selected. $\overline{LBO}$ is a static DC input.  |  |  |
| ŌĒ                            | Output Enable                    | I   | LOW    | Asynchronous output enable. $\overline{OE}$ must be low to read data from the 71V547. When $\overline{OE}$ is high the I/O pins are in a high-impedance state. $\overline{OE}$ does <u>not</u> need to be actively controlled for read and write cycles. In normal operation, $\overline{OE}$ can be tied low.   |  |  |
| VDD                           | Power Supply                     | N/A | N/A    | 3.3V power supply input.   |  |  |
| Vss                           | Ground                           | N/A | N/A    | Ground pin.  |  |  |

#### NOTE:

1. All synchronous inputs must meet specified setup and hold times with respect to CLK.

# Recommended Operating Temperature and Supply Voltage

| Grade      | Temperature    | Vss | <b>V</b> DD |
|------------|----------------|-----|-------------|
| Commercial | 0°C to +70°C   | 0V  | 3.3V±5%     |
| Industrial | -40°C to +85°C | 0V  | 3.3V±5%     |

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## Recommended DC Operating Conditions

| Symbol | Parameter                   | Min.                | Тур. | Max.                   | Unit |
|--------|-----------------------------|---------------------|------|------------------------|------|
| VDD    | Supply Voltage              | 3.135               | 3.3  | 3.465                  | V    |
| Vss    | Ground                      | 0                   | 0    | 0                      | V    |
| V⊪     | Input High Voltage - Inputs | 2.0                 |      | 4.6                    | V    |
| V⊪     | Input High Voltage - I/O    | 2.0                 |      | VDD+0.3 <sup>(2)</sup> | V    |
| VIL    | Input Low Voltage           | -0.5 <sup>(1)</sup> |      | 0.8                    | V    |

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#### NOTES:

- 1. VIL (min.) = -1.0V for pulse width less than tcyc/2, once per cycle.
- 2. ViH (max.) = +6.0V for pulse width less than tcyc/2, once per cycle.

#### **Capacitance**

#### (TA = +25°C, f = 1.0MHz, TQFP package)

| Symbol | Parameter <sup>(1)</sup> | Conditions | Max. | Unit |
|--------|--------------------------|------------|------|------|
| Cin    | Input Capacitance        | VIN = 3dV  | 5    | pF   |
| Cı/o   | I/O Capacitance          | Vout = 3dV | 7    | pF   |

#### NOTE:

1. This parameter is guaranteed by device characterization, but not production tested.

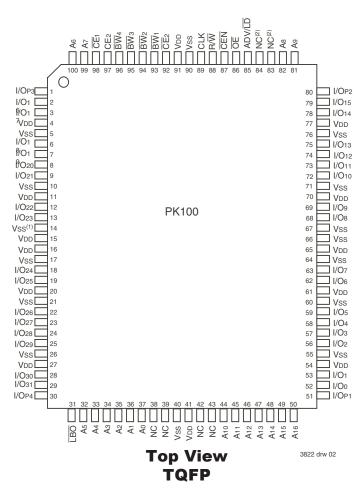
### Absolute Maximum Ratings(1)

| Symbol               | Rating  | Value            | Unit |  |  |  |  |  |
|----------------------|---|------------------|------|--|--|--|--|--|
| VTERM <sup>(2)</sup> | Supply Voltage on VDD with Respect to GND                             | -0.5 to +3.6     | V    |  |  |  |  |  |
| VTERM <sup>(3)</sup> | DC Input Voltage <sup>(5)</sup>                                       | -0.5 to VDDQ+0.5 | V    |  |  |  |  |  |
| VTERM <sup>(4)</sup> | DC Voltage Applied to Outputs in High-Z State <sup>(5)</sup>          | -0.5 to VDDQ+0.5 | V    |  |  |  |  |  |
| ТА                   | Operating Temperature   | 0°C to 70°C      | °C   |  |  |  |  |  |
| TBIAS                | Ambient Temperature with Power<br>Applied (Temperature Under<br>Bias) | -55 to +125      | °C   |  |  |  |  |  |
| Tstg                 | Storage Temperature   | -65 to +150      | °C   |  |  |  |  |  |
| Іоит                 | Current into Outputs (Low)  | 20               | mA   |  |  |  |  |  |
| VESD                 | Static Discharge Voltage (per MIL-STD-883, Method 3015)               | >2001            | V    |  |  |  |  |  |
| ILU                  | Latch-Up Current  | >200             | mA   |  |  |  |  |  |

NOTES:

- Stresses greater than those listed under ABSOLUTE MAXIMUM RATINGS may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.
- 2. VDD and Input terminals only.
- 3. I/O terminals.

## **Pin Configuration**



#### NOTES:

- 1. Pin 14 does not have to be connected directly to Vss as long as the input voltage is  $\leq$  VIL.
- 2. Pins 83 and 84 are reserved for future A<sub>17</sub> (8M) and A<sub>18</sub> (16M) respectively.

## Synchronous Truth Table<sup>(1)</sup>

| CEN | R/W | Chip <sup>(5)</sup><br>Enable | ADV/LD | B₩x   | ADDRESS<br>USED | PREVIOUIS CYCLE            | CURRENT CYCLE                          | I/O<br>(1 cycle later) |
|-----|-----|-------------------------------|--------|-------|-----------------|----------------------------|--|------------------------|
| L   | L   | Select                        | L      | Valid | External        | Х                          | LOAD WRITE                             | D <sup>(7)</sup>       |
| L   | Н   | Select                        | L      | Х     | External        | X                          | LOAD READ                              | Q <sup>(7)</sup>       |
| L   | Х   | Х                             | Н      | Valid | Internal        | LOAD WRITE/<br>BURST WRITE | BURST WRITE (Advance Burst Counter)(2) | D <sup>(7)</sup>       |
| L   | Х   | Х                             | Н      | Х     | Internal        | LOAD READ/<br>BURST READ   | BURST READ (Advance Burst Counter)(2)  | Q <sup>(7)</sup>       |
| L   | Χ   | Deselect                      | L      | Х     | Х               | Х                          | DESELECT or STOP(3)                    | HiZ                    |
| L   | Х   | Х                             | Н      | Х     | Х               | DESELECT / NOOP            | NOOP                                   | HiZ                    |
| Н   | Χ   | Х                             | Х      | Х     | Х               | Х                          | SUSPEND <sup>(4)</sup>                 | Previous Value         |

#### NOTES:

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- 1. L = VIL, H = VIH, X = Don't Care.
- 2. When ADV/\overline{\text{LD}} signal is sampled high, the internal burst counter is incremented. The R/\overline{\text{W}} signal is ignored when the counter is advanced. Therefore the nature of the burst cycle (Read or Write) is determined by the status of the R/\overline{\text{W}} signal when the first address is loaded at the beginning of the burst cycle.
- 3. Deselect cycle is initiated when either (CE1, or CE2 is sampled high or CE2 is sampled low) and ADV/LD is sampled low at rising edge of clock. The data bus will tri-state one cycle after deselect is initiated.
- 4. When  $\overline{\text{CEN}}$  is sampled high at the rising edge of clock, that clock edge is blocked from propagating through the part. The state of all the internal registers and the I/Os remains unchanged.
- 5. To select the chip requires  $\overline{\text{CE}}1$  = L,  $\overline{\text{CE}}2$  = L and CE2 = H on these chip enable pins. The chip is deselected if either one of thechip enable is false.
- 6. Device Outputs are ensured to be in High-Z during device power-up.
- 7. Q data read from the device, D data written to the device.

### Partial Truth Table for Writes(1)

| Operation  | R/W | BW₁ | BW <sub>2</sub> | BW <sub>3</sub> | BW <sub>4</sub> |
|--|-----|-----|-----------------|-----------------|-----------------|
| READ   | Н   | X   | Х               | Х               | Х               |
| WRITE ALL BYTES  | L   | L   | L               | L               | L               |
| WRITE BYTE 1 (VO [0:7], VOP1)(2)                             | L   | L   | Н               | Н               | Н               |
| WRITE BYTE 2 (I/O [8:15], I/O <sub>P2</sub> ) <sup>(2)</sup> | L   | Н   | L               | Н               | Н               |
| WRITE BYTE 3 (I/O [16:23], I/Op3) <sup>(2)</sup>             | L   | Н   | Н               | L               | Н               |
| WRITE BYTE 4 (I/O [24:31], I/OP4)(2)                         | L   | Н   | Н               | Н               | Ĺ               |
| NO WRITE   | L   | Н   | Н               | Н               | Н               |

#### NOTES:

- 1. L = VIL, H = VIH, X = Don't Care.
- 2. Multiple bytes may be selected during the same cycle.

## Interleaved Burst Sequence Table (LBO=VDD)

|                               | Sequence 1 | Sequence 2 | Sequence 3 | Sequence 4 |  |
|-------------------------------|------------|------------|------------|------------|--|
|                               | A1 A0      | A1 A0      | A1 A0      | A1 A0      |  |
| First Address                 | 0 0        | 0 1        | 1 0        | 1 1        |  |
| Second Address                | 0 1        | 0 0        | 1 1        | 1 0        |  |
| Third Address                 | 1 0        | 1 1        | 0 0        | 0 1        |  |
| Fourth Address <sup>(1)</sup> | 1 1        | 1 0        | 0 1        | 0 0        |  |

NOTE:

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Linear Burst Sequence Table (LBO=Vss)

|                               | Sequence 1 | Sequence 2 | Sequence 3 | Sequence 4 |
|-------------------------------|------------|------------|------------|------------|
|                               | A1 A0      | A1 A0      | A1 A0      | A1 A0      |
| First Address                 | 0 0        | 0 1        | 1 0        | 1 1        |
| Second Address                | 0 1        | 1 0        | 1 1        | 0 0        |
| Third Address                 | 1 0        | 1 1        | 0 0        | 0 1        |
| Fourth Address <sup>(1)</sup> | 1 1        | 0 0        | 0 1        | 1 0        |

NOTE:

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## Functional Timing Diagram<sup>(1)</sup>

| CYCLE   | n+29  | n+30  | n+31  | n+32    | n+33  | n+34  | n+35  | n+36  | n+37  |  |
|---|-------|-------|-------|---------|-------|-------|-------|-------|-------|--|
| CLOCK   |       |       |       | <b></b> |       |       |       |       |       |  |
| ADDRESS (2)<br>(A0 - A16)                           | A29   | A30   | A31   | A32     | A33   | A34   | A35   | A36   | A37   |  |
| CONTROL <sup>(2)</sup><br>(R/W, ADV/LD, BWx)        | C29   | C30   | C31   | C32     | C33   | C34   | C35   | C36   | C37   |  |
| <b>DATA<sup>(2)</sup></b><br>I/O [0:31], I/O P[1:4] | D/Q28 | D/Q29 | D/Q30 | D/Q31   | D/Q32 | D/Q33 | D/Q34 | D/Q35 | D/Q36 |  |

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#### NOTE:

- 1. This assumes  $\overline{\text{CEN}}$ ,  $\overline{\text{CE1}}$ , CE2 and  $\overline{\text{CE2}}$  are all true.
- 2. All Address, Control and Data\_in are only required to meet set-up and hold time with respect to the rising edge of clock. Data\_Out is valid after a clock-to-data delay from the rising edge of clock.

<sup>1.</sup> Upon completion of the Burst sequence the counter wraps around to its initial state and continues counting.

<sup>1.</sup> Upon completion of the Burst sequence the counter wraps around to its initial state and continues counting.

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# Device Operation - Showing Mixed Load, Burst, Deselect and NOOP Cycles<sup>(2)</sup>

| Cycle | Address | R/W | ADV/LD | CE(1) | CEN | B₩x | ŌĒ | I/O  | Comments         |
|-------|---------|-----|--------|-------|-----|-----|----|------|------------------|
| n     | A0      | Н   | L      | L     | L   | Х   | Х  | D1   | Load read        |
| n+1   | Х       | Х   | Н      | Х     | L   | Х   | L  | Q0   | Burst read       |
| n+2   | A1      | Н   | L      | L     | L   | Х   | L  | Q0+1 | Load read        |
| n+3   | Х       | Х   | L      | Н     | L   | Х   | L  | Q1   | Deselect or STOP |
| n+4   | Х       | Х   | Н      | Х     | L   | Х   | Х  | Z    | NOOP             |
| n+5   | A2      | Н   | L      | L     | L   | Х   | Х  | Z    | Load read        |
| n+6   | Х       | Х   | Н      | Х     | L   | Х   | L  | Q2   | Burst read       |
| n+7   | Х       | Х   | L      | Н     | L   | Х   | L  | Q2+1 | Deselect or STOP |
| n+8   | A3      | L   | L      | L     | L   | L   | Х  | Z    | Load write       |
| n+9   | Х       | Х   | Н      | Х     | L   | L   | Х  | D3   | Burst write      |
| n+10  | A4      | L   | L      | L     | L   | L   | Х  | D3+1 | Load write       |
| n+11  | Х       | Х   | L      | Н     | L   | Х   | Х  | D4   | Deselect or STOP |
| n+12  | Х       | Х   | Н      | Х     | L   | Х   | Х  | Z    | NOOP             |
| n+13  | A5      | L   | L      | L     | L   | L   | Х  | Z    | Load write       |
| n+14  | A6      | Н   | L      | L     | L   | Х   | Х  | D5   | Load read        |
| n+15  | A7      | L   | L      | L     | L   | L   | L  | Q6   | Load write       |
| n+16  | Х       | Х   | Н      | Х     | L   | L   | Х  | D7   | Burst write      |
| n+17  | A8      | Н   | L      | L     | L   | Х   | Х  | D7+1 | Load read        |
| n+18  | Х       | Х   | Н      | Х     | L   | Х   | L  | Q8   | Burst read       |
| n+19  | A9      | L   | L      | L     | L   | L   | L  | Q8+1 | Load write       |

NOTE:

<sup>1.</sup>  $\overline{\text{CE}}2$  timing transition is identical to  $\overline{\text{CE}}1$  signal. CE2 timing transition is identical but inverted to the  $\overline{\text{CE}}1$  and  $\overline{\text{CE}}2$  signals.

<sup>2.</sup> H = High; L = Low; X = Don't Care; Z = High Impedence.

Read Operation(1)

| Cycle | Address | R/W | ADV/LD | CE(2) | CEN | B₩x | ŌĒ | I/O | Comments                        |  |  |  |
|-------|---------|-----|--------|-------|-----|-----|----|-----|---------------------------------|--|--|--|
| n     | A0      | Н   | L      | L     | L   | Χ   | Χ  | Χ   | Address and Control meet setup  |  |  |  |
| n+1   | Х       | Х   | Х      | Χ     | Χ   | Χ   | L  | Q0  | Contents of Address A0 Read Out |  |  |  |

NOTE:

3822 tbl 12

- 1. H = High; L = Low; X = Don't Care; Z = High Impedance.
- 2.  $\overline{\text{CE}}2$  timing transition is identical to  $\overline{\text{CE}}1$  signal.  $\overline{\text{CE}}2$  timing transition is identical but inverted to the  $\overline{\text{CE}}1$  and  $\overline{\text{CE}}2$  signals.

**Burst Read Operation**(1)

| Cycle | Address | R/W | ADV/LD | CE <sup>(2)</sup> | CEN | B₩x | ŌĒ | 1/0  | Comments                          |  |  |
|-------|---------|-----|--------|-------------------|-----|-----|----|------|-----------------------------------|--|--|
| n     | A0      | Н   | L      | L                 | L   | Χ   | Χ  | Х    | Address and Control meet setup    |  |  |
| n+1   | Х       | Х   | Н      | Х                 | L   | Х   | L  | Q0   | Address A0 Read Out, Inc. Count   |  |  |
| n+2   | Х       | Х   | Н      | Х                 | L   | Х   | L  | Q0+1 | Address A0+1 Read Out, Inc. Count |  |  |
| n+3   | Х       | Х   | Н      | Х                 | L   | Х   | L  | Q0+2 | Address A0+2 Read Out, Inc. Count |  |  |
| n+4   | Х       | Х   | Н      | Х                 | L   | Х   | L  | Q0+3 | Address A0+3 Read Out, Load A1    |  |  |
| n+5   | A1      | Н   | L      | L                 | L   | Х   | L  | Q0   | Address A0 Read Out, Inc. Count   |  |  |
| n+6   | Х       | Х   | Н      | Χ                 | L   | Х   | L  | Q1   | Address A1 Read Out, Inc. Count   |  |  |
| n+7   | A2      | Н   | L      | L                 | L   | Х   | L  | Q1+1 | Address A1+1 Read Out, Load A2    |  |  |

3822 tbl 13

NOTE:

- 1. H = High; L = Low; X = Don't Care; Z = High Impedance.
- 2. CE2 timing transition is identical to CE1 signal. CE2 timing transition is identical but inverted to the CE1 and CE2 signals.

## Write Operation(1)

| Cycle | • | Address | R/W | ADV/LD | <del>C</del> E <sup>(2)</sup> | CEN | B₩x | ŌĒ | I/O | Comments                       |
|-------|---|---------|-----|--------|-------------------------------|-----|-----|----|-----|--------------------------------|
| n     |   | A0      | L   | L      | L                             | L   | L   | Χ  | Х   | Address and Control meet setup |
| n+1   |   | X       | Х   | Х      | Χ                             | L   | Χ   | X  | D0  | Write to Address A0            |

NOTE

3822 tbl 14

- 1.  $\underline{H}$  = High; L = Low; X = Don't Care;  $\underline{Z}$  = High Impedance.
- 2.  $\overline{\text{CE}2}$  timing transition is identical to  $\overline{\text{CE}1}$  signal. CE2 timing transition is identical but inverted to the  $\overline{\text{CE}1}$  and  $\overline{\text{CE}2}$  signals.

## **Burst Write Operation**(1)

| Cycle | Address | R/W | ADV/LD | CE <sup>(2)</sup> | CEN | B₩x | ŌĒ | I/O  | Comments  |
|-------|---------|-----|--------|-------------------|-----|-----|----|------|---|
| n     | A0      | L   | L      | L                 | L   | L   | Х  | Χ    | Address and Control meet setup                      |
| n+1   | Х       | Х   | Н      | Χ                 | L   | L   | Χ  | D0   | Address A0 Write, Inc. Count                        |
| n+2   | Х       | Х   | Н      | Х                 | L   | L   | Х  | D0+1 | Address A0+1 Write, Inc. Count                      |
| n+3   | Х       | Х   | Н      | Х                 | L   | L   | Χ  | D0+2 | Address A <sub>0+2</sub> Write, Inc. Count          |
| n+4   | Х       | Х   | Н      | Х                 | L   | L   | Х  | D0+3 | Address A <sub>0+3</sub> Write, Load A <sub>1</sub> |
| n+5   | A1      | L   | L      | L                 | L   | L   | Χ  | D0   | Address A0 Write, Inc. Count                        |
| n+6   | Х       | Χ   | Н      | Χ                 | L   | L   | Х  | D1   | Address A1 Write, Inc. Count                        |
| n+7   | A2      | L   | L      | L                 | L   | L   | Χ  | D1+1 | Address A1+1 Write, Load A2                         |

NOTE:

- 1. H = High; L = Low; X = Don't Care; Z = High Impedance.
- 2.  $\overline{\text{CE}}2$  timing transition is identical to  $\overline{\text{CE}}1$  signal.  $\overline{\text{CE}}2$  timing transition is identical but inverted to the  $\overline{\text{CE}}1$  and  $\overline{\text{CE}}2$  signals.

## Read Operation With Clock Enable Used(1)

| Cycle | Address | R/W | ADV/LD | CE <sup>(2)</sup> | CEN | B₩x | ŌĒ | 1/0 | Comments                             |  |  |
|-------|---------|-----|--------|-------------------|-----|-----|----|-----|--------------------------------------|--|--|
| n     | A0      | Н   | L      | L                 | L   | Х   | Х  | Х   | Address and Control meet setup       |  |  |
| n+1   | Х       | Х   | Х      | Х                 | Н   | Х   | Х  | Х   | Clock n+1 Ignored                    |  |  |
| n+2   | A1      | Н   | L      | L                 | L   | Х   | L  | Q0  | Address A0 Read out, Load A1         |  |  |
| n+3   | Х       | Χ   | Х      | Χ                 | Н   | Х   | L  | Q0  | Clock Ignored. Data Q0 is on the bus |  |  |
| n+4   | Х       | Х   | Х      | Х                 | Н   | Х   | L  | Q0  | Clock Ignored. Data Q0 is on the bus |  |  |
| n+5   | A2      | Н   | L      | L                 | L   | Х   | L  | Q1  | Address A1 Read out, Load A2         |  |  |
| n+6   | A3      | Н   | L      | L                 | L   | Х   | L  | Q2  | Address A2 Read out, Load A3         |  |  |
| n+7   | A4      | Н   | L      | L                 | L   | Х   | L  | Q3  | Address A3 Read out, Load A4         |  |  |

#### NOTE:

3822 tbl 16

- 1. H = High; L = Low; X = Don't Care; Z = High Impedance.
- 2.  $\overline{\text{CE}}2$  timing transition is identical to  $\overline{\text{CE}}1$  signal.  $\overline{\text{CE}}2$  timing transition is identical but inverted to the  $\overline{\text{CE}}1$  and  $\overline{\text{CE}}2$  signals.

## Write Operation With Clock Enable Used(1)

| Cycle | Address | R/W | ADV/LD | <u>C</u> E <sup>(2)</sup> | CEN | B₩x | ŌĒ | I/O | Comments                       |  |  |
|-------|---------|-----|--------|---------------------------|-----|-----|----|-----|--------------------------------|--|--|
| n     | A0      | L   | L      | L                         | L   | L   | Χ  | Χ   | Address and Control meet setup |  |  |
| n+1   | Х       | Χ   | Х      | Х                         | Н   | Х   | Χ  | Х   | Clock n+1 Ignored              |  |  |
| n+2   | A1      | L   | L      | L                         | L   | L   | Χ  | D0  | Write data D0, Load A1         |  |  |
| n+3   | Х       | Χ   | Х      | Х                         | Н   | Х   | Χ  | Х   | Clock Ignored                  |  |  |
| n+4   | Х       | Χ   | Х      | Х                         | Н   | Х   | Χ  | Х   | Clock Ignored                  |  |  |
| n+5   | A2      | L   | L      | L                         | L   | L   | Χ  | D1  | Write data D1, Load A2         |  |  |
| n+6   | А3      | L   | L      | L                         | L   | L   | Χ  | D2  | Write data D2, Load A3         |  |  |
| n+7   | A4      | L   | L      | L                         | L   | L   | Χ  | D3  | Write data D3, Load A4         |  |  |

3822 tbl 17

#### NOTE:

- 1. H = High; L = Low; X = Don't Care; Z = High Impedance.
- 2.  $\overline{\text{CE}}$ 2 timing transition is identical to  $\overline{\text{CE}}$ 1 signal.  $\overline{\text{CE}}$ 2 timing transition is identical but inverted to the  $\overline{\text{CE}}$ 1 and  $\overline{\text{CE}}$ 2 signals.

## Read Operation with Chip Enable Used(1)

| Cycle | Address | R/W | ADV/LD | CE(1) | CEN | B₩x | ŌĒ | I/O <sup>(3)</sup> | Comments                          |  |  |
|-------|---------|-----|--------|-------|-----|-----|----|--------------------|-----------------------------------|--|--|
| n     | Х       | Х   | L      | Н     | L   | Х   | Х  | ?                  | Deselected                        |  |  |
| n+1   | Х       | Х   | L      | Н     | L   | Х   | Х  | Z                  | Deselected                        |  |  |
| n+2   | A0      | Н   | L      | L     | L   | Х   | Χ  | Z                  | Address A0 and Control meet setup |  |  |
| n+3   | Х       | Х   | L      | Н     | L   | Х   | L  | Q0                 | Address A0 read out. Deselected   |  |  |
| n+4   | A1      | Н   | L      | L     | L   | Х   | Χ  | Z                  | Address A1 and Control meet setup |  |  |
| n+5   | Х       | Х   | L      | Н     | L   | Х   | L  | Q1                 | Address A1 Read out. Deselected   |  |  |
| n+6   | Х       | Х   | L      | Н     | L   | Х   | Χ  | Z                  | Deselected                        |  |  |
| n+7   | A2      | Н   | L      | L     | L   | Х   | Χ  | Z                  | Address A2 and Control meet setup |  |  |
| n+8   | Х       | Χ   | L      | Н     | L   | Х   | L  | Q2                 | Address A2 read out. Deselected   |  |  |
| n+9   | Х       | Х   | L      | Н     | L   | Х   | Χ  | Z                  | Deselected                        |  |  |

3822 tbl 18

#### NOTES:

- 1. H = High; L = Low; X = Don't Care; ? = Don't Know; Z = High Impedance.
- 2.  $\overline{\text{CE}}2$  timing transition is identical to  $\overline{\text{CE}}1$  signal. CE2 timing transition is identical but inverted to the  $\overline{\text{CE}}1$  and  $\overline{\text{CE}}2$  signals.
- 3. Device outputs are ensured to be in High-Z during device power-up.

## Write Operation with Chip Enable Used(1)

| Cycle | Address | R/W | ADV/LD | CE <sup>(1)</sup> | CEN | B₩x | ŌĒ | I/O | Comments                          |  |  |
|-------|---------|-----|--------|-------------------|-----|-----|----|-----|-----------------------------------|--|--|
| n     | Х       | Х   | L      | Н                 | L   | Х   | Χ  | ?   | Deselected                        |  |  |
| n+1   | Х       | Х   | L      | Н                 | L   | Х   | Х  | Z   | Deselected                        |  |  |
| n+2   | A0      | L   | L      | L                 | L   | L   | Х  | Z   | Address A0 and Control meet setup |  |  |
| n+3   | Х       | Х   | L      | Н                 | L   | Х   | Х  | D0  | Address D0 Write In. Deselected   |  |  |
| n+4   | A1      | L   | L      | L                 | L   | L   | Х  | Z   | Address A1 and Control meet setup |  |  |
| n+5   | Х       | Х   | L      | Н                 | L   | Х   | Х  | D1  | Address D1 Write In. Deselected   |  |  |
| n+6   | Х       | Х   | L      | Н                 | L   | Х   | Χ  | Z   | Deselected                        |  |  |
| n+7   | A2      | L   | L      | L                 | L   | L   | Х  | Z   | Address A2 and Control meet setup |  |  |
| n+8   | Х       | Χ   | L      | Н                 | L   | Χ   | Χ  | D2  | Address D2 Write In. Deselected   |  |  |
| n+9   | Х       | Х   | L      | Н                 | L   | Х   | Х  | Z   | Deselected                        |  |  |

- H = High; L = Low; X = Don't Care; ? = Don't Know; Z = High Impedance.
   \overline{CE} = L is defined as \overline{CE} = L, \overline{CE} = L and CE2 = H. \overline{CE} = H is defined as \overline{CE} = H, \overline{CE} = H or CE2 = L.

## **DC Electrical Characteristics Over the Operating Temperature and** Supply Voltage Range (VDD = 3.3V +/-5%)

| Symbol      | Parameter                    | Test Conditions   | Min. | Max. | Unit |
|-------------|------------------------------|---|------|------|------|
| Lu          | Input Leakage Current        | VDD = Max., VN = 0V to VDD  | _    | 5    | μA   |
| ILI         | LBO Input Leakage Current(1) | VDD = Max., VN = 0V to VDD  | _    | 30   | μA   |
| <b>I</b> LO | Output Leakage Current       | $\overline{CE} \ge V$ H or $\overline{OE} \ge V$ H, Vout = 0V toVpp, Vpp = Max. | _    | 5    | μA   |
| Vol         | Output Low Voltage           | IOL = 5mA, VDD = Min.   |      | 0.4  | V    |
| Vон         | Output High Voltage          | IOH = -5mA, VDD = Min.  | 2.4  | _    | V    |

1. The  $\overline{\text{LBO}}$  pin will be internally pulled to VDD if it is not actively driven in the application.

#### 3822 tbl 20

## **DC Electrical Characteristics Over the Operating Temperature** and Supply Voltage Range<sup>(1)</sup> (VDD = 3.3V +/-5%, VHD = VDD-0.2V, VLD = 0.2V)

|        |                                       |  |       | S80 |       | S85 |       | 90  | S100  |     |      |
|--------|---------------------------------------|--|-------|-----|-------|-----|-------|-----|-------|-----|------|
| Symbol | Parameter                             | Test Conditions  | Com'l | Ind | Com'l | Ind | Com'l | Ind | Com'l | Ind | Unit |
| loo    | Operating Power Supply Current        | Device Selected, Outputs Open, ADV/ $\overline{\text{LD}}$ = X, V <sub>DD</sub> = Max., V <sub>IN</sub> $\geq$ V <sub>I</sub> H or $\leq$ V <sub>IL</sub> , f = f <sub>M</sub> ax <sup>(2)</sup> | 250   | 260 | 225   | 235 | 225   | 235 | 200   | 210 | mA   |
| ISB1   | CMOS Standby Power<br>Supply Current  | Device Deselected, Outputs Open, $VDD = Max., VIN \ge VHD \text{ or } \le VLD, f = 0^{(2)}$  | 40    | 45  | 40    | 45  | 40    | 45  | 40    | 45  | mA   |
| ISB2   | Clock Running Power<br>Supply Current | Device Deselected, Outputs Open, VDD = Max., VIN ≥ VHD or ≤ VLD, f = fMAX <sup>(2)</sup>   | 100   | 110 | 95    | 105 | 95    | 105 | 90    | 100 | mA   |
| ISB3   | ldle Power<br>Supply Current          | Device Selected, Outputs Open, $\overline{CEN} \ge VIHVDD = Max., VIN \ge VHD or \le VLD, f = fMAX^{(2)}$  | 40    | 45  | 40    | 45  | 40    | 45  | 40    | 45  | mA   |

#### NOTES:

1. All values are maximum guaranteed values.

2. At f = fMAX, inputs are cycling at the maximum frequency of read cycles of 1/tcyc; f=0 means no input lines are changing.

3822 tbl 21

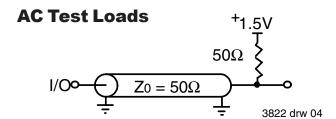


Figure 1. AC Test Load

#### AC Test Conditions

| Input Pulse Levels             | 0 to 3V      |
|--------------------------------|--------------|
| Input Rise/Fall Times          | 2ns          |
| Input Timing Reference Levels  | 1.5V         |
| Output Timing Reference Levels | 1.5V         |
| AC Test Load                   | See Figure 1 |

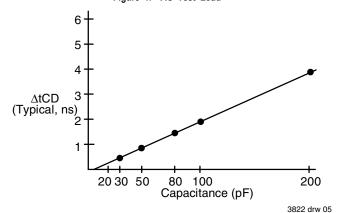


Figure 2. Lumped Capacitive Load, Typical Derating

#### **AC Electrical Characteristics**

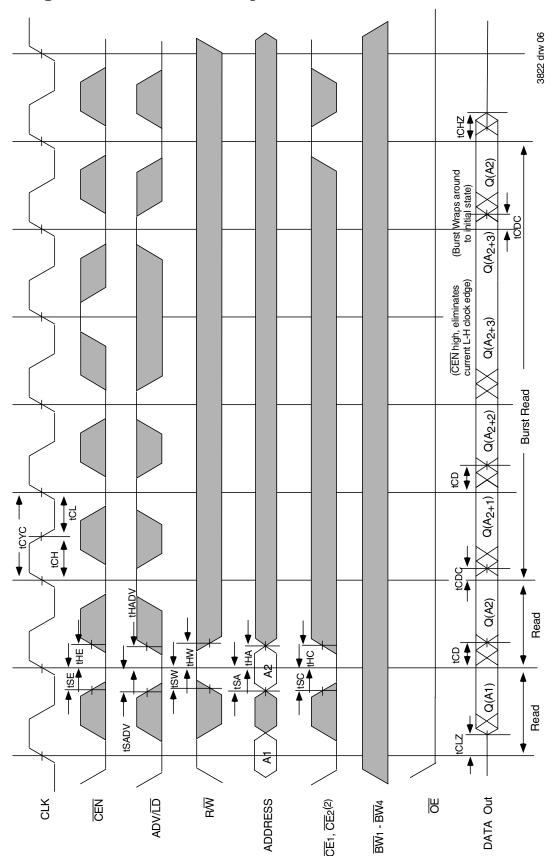
### (VDD = 3.3V +/-5%, Commercial and Industrial Temperature Ranges)

|                       |                                    | 71V5 | 47S80 | 71V5 | 47 <b>S</b> 85 | 71V5 | 47 <b>S</b> 90 | 71V54 |      |      |
|-----------------------|------------------------------------|------|-------|------|----------------|------|----------------|-------|------|------|
| Symbol                | Parameter                          | Min. | Max.  | Min. | Max.           | Min. | Max.           | Min.  | Max. | Unit |
| Clock Paramo          | eters                              | •    | •     | •    | •              | •    | •              | •     | •    |      |
| tcyc                  | Clock Cycle Time                   | 10.5 |       | 11   |                | 12   |                | 15    | _    | ns   |
| tcH <sup>(2)</sup>    | Clock High Pulse Width             | 3    |       | 3.9  | _              | 4    | _              | 5     | _    | ns   |
| tcL <sup>(2)</sup>    | Clock Low Pulse Width              | 3    |       | 3.9  | —              | 4    | —              | 5     |      | ns   |
| Output Paran          | neters                             |      |       |      |                |      |                |       |      |      |
| tcD                   | Clock High to Valid Data           | _    | 8     | —    | 8.5            |      | 9              |       | 10   | ns   |
| tcpc                  | Clock High to Data Change          | 2    |       | 2    | _              | 2    | —              | 2     | _    | ns   |
| to_z(3,4,5)           | Clock High to Output Active        | 4    |       | 4    | _              | 4    | _              | 4     | _    | ns   |
| tcHz(3,4,5)           | Clock High to Data High-Z          | _    | 5     | _    | 5              | _    | 5              | _     | 5    | ns   |
| toE                   | Output Enable Access Time          | _    | 5     | _    | 5              | _    | 5              | _     | 5    | ns   |
| toLz(3,4)             | Output Enable Low to Data Active   | 0    |       | 0    | _              | 0    | —              | 0     | _    | ns   |
| toHz <sup>(3.4)</sup> | Output Enable High to Data High-Z  | _    | 5     | _    | 5              | _    | 5              | _     | 5    | ns   |
| Setup Times           |                                    |      |       |      |                |      |                |       |      |      |
| tse                   | Clock Enable Setup Time            | 2.0  | _     | 2.0  | _              | 2.0  | _              | 2.5   | _    | ns   |
| tsa                   | Address Setup Time                 | 2.0  | _     | 2.0  | _              | 2.0  | _              | 2.5   | _    | ns   |
| tsp                   | Data in Setup Time                 | 2.0  |       | 2.0  | _              | 2.0  | _              | 2.5   | _    | ns   |
| tsw                   | Read/Write (R/W) Setup Time        | 2.0  |       | 2.0  | _              | 2.0  | _              | 2.5   | _    | ns   |
| tsadv                 | Advance/Load (ADV/LD) Setup Time   | 2.0  | _     | 2.0  | _              | 2.0  | _              | 2.5   | _    | ns   |
| tsc                   | Chip Enable/Select Setup Time      | 2.0  | _     | 2.0  | _              | 2.0  | _              | 2.5   | _    | ns   |
| tsB                   | Byte Write Enable (BWx) Setup Time | 2.0  | _     | 2.0  | _              | 2.0  | _              | 2.5   | _    | ns   |
| Hold Times            |                                    |      |       |      |                |      |                |       |      |      |
| the                   | Clock Enable Hold Time             | 0.5  | _     | 0.5  | _              | 0.5  | _              | 0.5   | _    | ns   |
| tha                   | Address Hold Time                  | 0.5  | _     | 0.5  | _              | 0.5  | _              | 0.5   | _    | ns   |
| tho                   | Data in Hold Time                  | 0.5  |       | 0.5  | _              | 0.5  | _              | 0.5   | _    | ns   |
| thw                   | Read/Write (R/W) Hold Time         | 0.5  |       | 0.5  | _              | 0.5  | _              | 0.5   | _    | ns   |
| thadv                 | Advance/Load (ADV/LD) Hold Time    | 0.5  |       | 0.5  |                | 0.5  |                | 0.5   |      | ns   |
| tнc                   | Chip Enable/Select Hold Time       | 0.5  | _     | 0.5  |                | 0.5  |                | 0.5   |      | ns   |
| tнв                   | Byte Write Enable (BWx) Hold Time  | 0.5  | _     | 0.5  | _              | 0.5  | _              | 0.5   | _    | ns   |

#### NOTES:

- 1. Measured as HIGH above 2.0V and LOW below 0.8V.
- 2. Transition is measured ±200mV from steady-state.
- 3. These parameters are guaranteed with the AC load (Figure 1) by device characterization. They are not production tested.
- 4. To avoid bus contention, the output buffers are designed such that tOHZ (device turn-off) is about 2 ns faster than toLZ (device turn-on) at a given temperature and voltage. The specs as shown do not imply bus contention because toLZ is a Min. parameter that is worse case at totally different test conditions (0 deg. C, 3.465V) than toHZ, which is a Max. parameter (worse case at 70 deg. C, 3.135V).

## Timing Waveform of Read Cycle<sup>(1, 2, 3, 4)</sup>



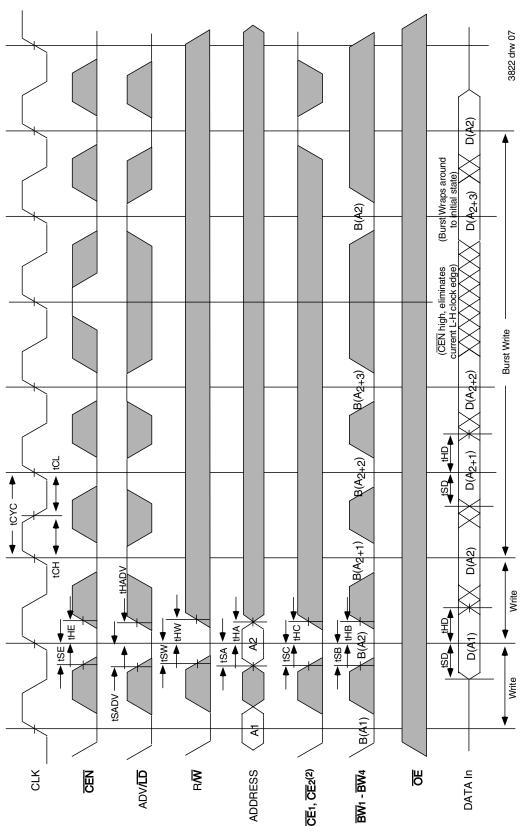
- 1. Q (A) represents the first output from the external address A1. Q (A2) represents the first output from the external address A2; Q (A2+1) represents the next output data in the burst sequence of the base address A2, etc. where address bits A0 and A1 are advancing for the four word burst in the sequence defined by the state of the LBO input.

  2. CE2 timing transitions are identical but inverted to the CE1 and CE2 signals. For example, when CE1 and CE2 are LOW on this waveform, CE2 is HIGH.

  3. Burst ends when new address and control are loaded into the SRAM by sampling ADV/LD LOW.

  4. RW is don't care when the SRAM is bursting (ADV/LD sampled HIGH). The nature of the burst access (Read or Write) is fixed by the state of the R/W signal when new address and control are loaded into the SRAM.

## Timing Waveform of Write Cycles<sup>(1,2,3,4,5)</sup>



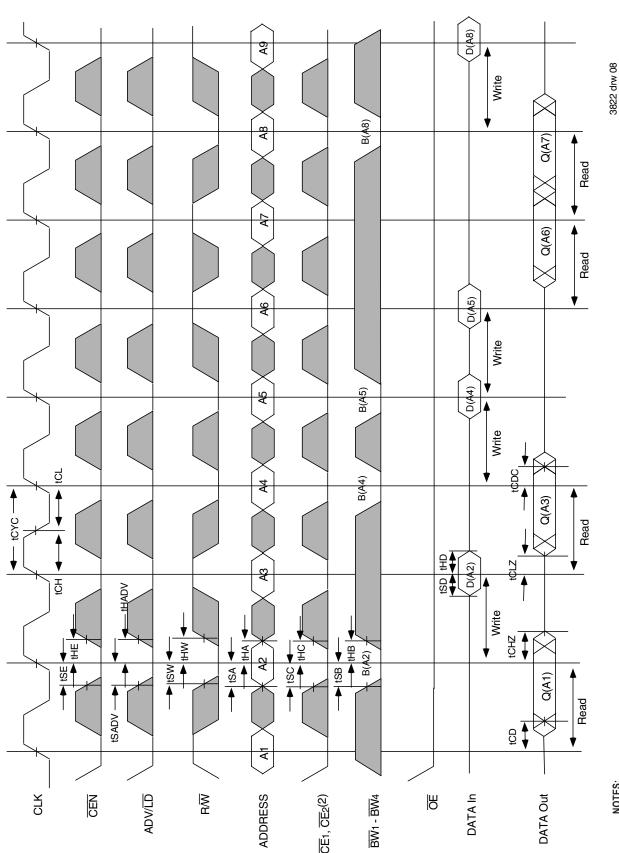
- 1. D(A1) represents the first input to the external address A1. D(A2) represents the first input to the external address A2; D(A2+1) represents the next input data in the burst sequence of the base
- 2 ε. 4.
- address A2, etc. where address bits A0 and A1 are advancing for the four word burst in the sequence defined by the state of the LBO input.

  CE2 timing transitions are identical but inverted to the CE1 and CE2 signals. For example, when CE1 and CE2 are LOW on this waveform, CE2 is HIGH.

  Burst ends when new address and control are loaded into the SRAM by sampling ADVILD LOW.

  RWisdon't care when the SRAM is bursting (ADVILD sampled HIGH). The nature of the burst access (Read or Write) is fixed by the state of the RWisignal when new address and control are loaded into the SRAM.
  - Individual Byte Write signals (BWx) must be valid on all write and burst-write cycles. A write cycle is initiated when RW signal is sampled LOW. The byte write information comes in one cycle before the actual data is presented to the SRAM. 5.

## Timing Waveform of Combined Read and Write Cycles<sup>(1,2,3)</sup>



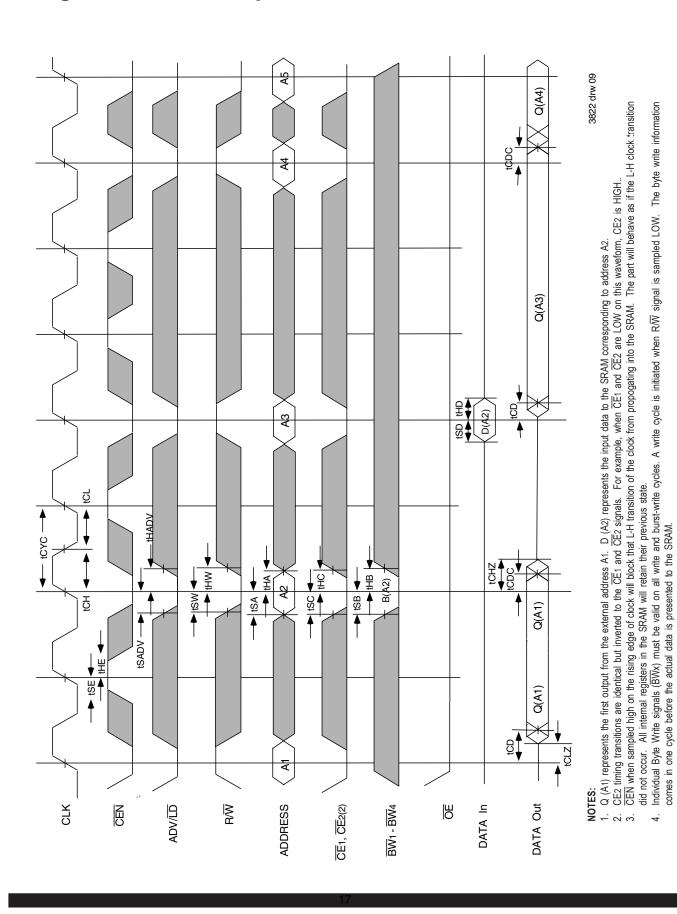
NOTES:

<sup>1.</sup> Q (A1) represents the first output from the external address A1. D (A2) represents the input data to the SRAM corresponding to address A2.

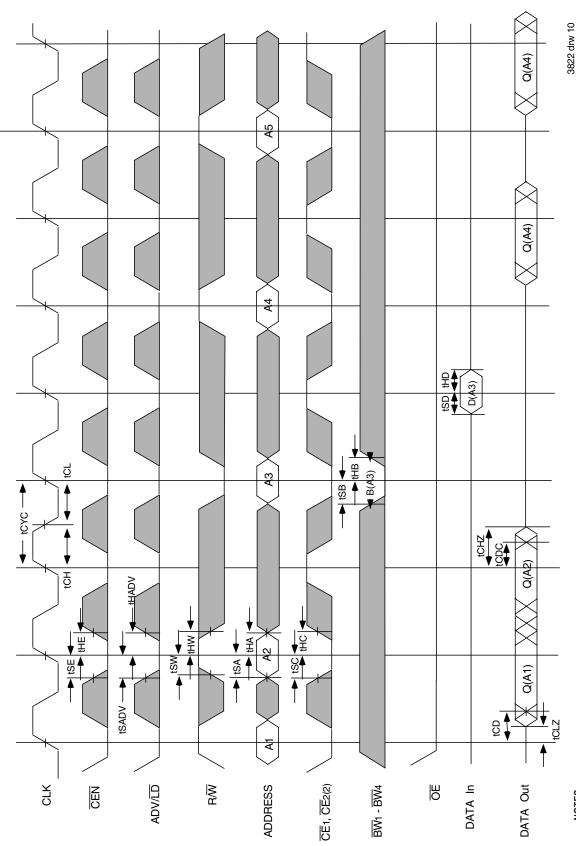
2. CE2 timing transitions are identical but inverted to the CE1 and CE2 signals. For example, when CE1 and CE2 are LOW on this waveform, CE2 is HIGH.

3. Individual Byte Write signals (BWx) must be valid on all write and burst-write cycles. A write cycle is initiated when R/W signal is sampled LOW. The byte write information comes in one cycle before the actual data is presented to the SRAM.

## Timing Waveform of **CEN** Operation<sup>(1,2,3,4)</sup>

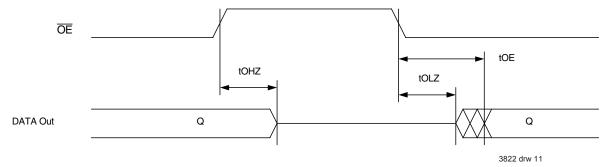


## Timing Waveform of $\overline{\text{CS}}$ Operation<sup>(1,2,3,4)</sup>



- Q (A1) represents the first output from the external address A1. D (A3) represents the input data to the SRAM corresponding to address A3 etc.
  CE2 timing transitions are identical but inverted to the CE1 and CE2 signals. For example, when CE1 and CE2 are LOW on this waveform, CE2 is HIGH.
  When either one of the Chip enables (CE1, CE2, CE2) is sampled inactive at the rising clock edge, a deselect cycle is initiated. The data-bus tri-states one cycle after the initiation of the deselect cycle. This allows for any pending data transfers (reads or writes) to be completed.
- Individual Byte Write signals (BWx) must be valid on all write and burst-write cycles. A write cycle is initiated when RW signal is sampled LOW. The byte write information comes in one cycle before the actual data is presented to the SRAM.

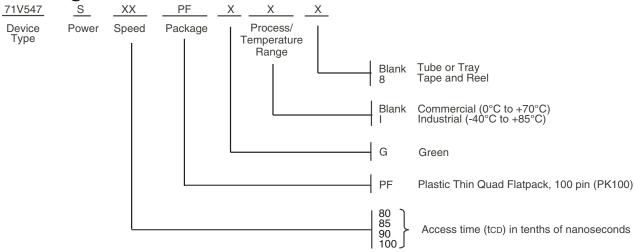
## Timing Waveform of $\overline{OE}$ Operation<sup>(1)</sup>



#### NOTE:

1. A read operation is assumed to be in progress.

## **Ordering Information**



| PART NUMBER  | tcd PARAMETER | SPEED IN MEGAHERTZ | CLOCK CYCLE TIME |
|--------------|---------------|--------------------|------------------|
| 71V547S80PF  | 8 ns          | 95 MHz             | 10.5 ns          |
| 71V547S85PF  | 8.5 ns        | 90 MHz             | 11 ns            |
| 71V547S90PF  | 9 ns          | 83 MHz             | 12 ns            |
| 71V547S100PF | 10 ns         | 66 MHz             | 15 ns            |
| l l          |               |                    |                  |

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## **Datasheet Document History**

| 6/15/99  |                   | Updated to new format  |
|----------|-------------------|--|
| 9/13/99  | Pg. 11            | Corrected ISB3 conditions  |
|          | Pg. 19            | Added Datasheet Document History   |
| 12/31/99 | Pp. 3, 11, 12, 18 | Added Industrial Temperature range offerings   |
| 02/27/07 | Pg.18             | Added X generation die step to data sheet ordering information                                 |
| 10/16/08 | Pg. 18            | Removed "IDT" from orderable part number   |
| 05/27/10 | Pg. 17            | Added "Restricted hazardous substance device" to the ordering information                      |
| 02/23/15 | Pg 1-3            | Re-ordered the FBD, Pin Descriptions and Pin Definitions to make the reading flow better match |
|          |                   | the reading flow of our other datasheets   |
|          | Pg 5&19           | PK100-1 changed to PK100 to match our package codes  |
|          | Pg 19             | RoHS updated to Green, added Tape and Reel and removed die stepping from the Ordering          |
|          |                   | Information  |



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